

**Amendment and Response**

Applicant: Wolfgang Hetzel et al.

Serial No.: 10/577,173

Filed: October 27, 2009

Docket No.: I441.141.101/QIM4346

Title: SEMICONDUCTOR DEVICE WITH PLASTIC PACKAGE MOLDING COMPOUND,  
SEMICONDUCTOR CHIP AND LEADFRAME AND METHOD FOR PRODUCING SAME

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**REMARKS**

The following remarks are made in response to the Ex Parte Quayle Office Action mailed January 19, 2011. Claims 16, 19, 22-25, 27, 30-33, 36-40 remain pending in the application and are presented for reconsideration and allowance.

**Drawing Objections**

A replacement drawing sheet is included with an amended Figure 2 that identifies a microgap 17 between the gold layer 14 and the plastic package molding compound 2. The specification has been amended to include reference number 17.

The objection to the drawings is therefore believed to be overcome.

**Allowable claims**

The Office Action states that claims 16, 19, 22-25, 27, 30-33, 36-38 are allowable. However, in the previous Office Action, claims 36-40 were added. Claims 16, 19, 22-25, 27, 30-33, 36-40 are therefore pending and are believed to be in condition for allowance.

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**CONCLUSION**

In view of the above, Applicant respectfully submits that the objection to the drawings is overcome.

No fees are required under 37 C.F.R. 1.16(h)(i). However, if such fees are required, the Patent Office is hereby authorized to charge Deposit Account No. 50-0471.

Please consider this a Petition for Extension of Time for a sufficient number of months to enter these papers, if appropriate. At any time during the pendency of this application, please charge any additional fees or credit overpayment to Deposit Account No. 500471.

The Examiner is invited to contact the Applicant's representative at the below-listed telephone numbers to facilitate prosecution of this application.

Any inquiry regarding this Amendment and Response should be directed to Mark L. Gleason at Telephone No. (612) 767-2503, Facsimile No. (612) 573-2005. In addition, all correspondence should continue to be directed to the following address:

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Respectfully submitted,

Wolfgang Hetzel et al.,

By their attorneys,

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